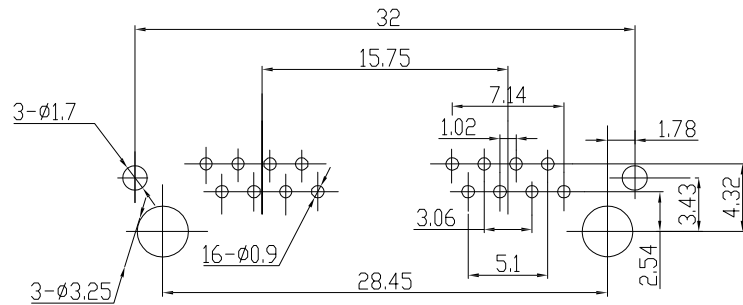


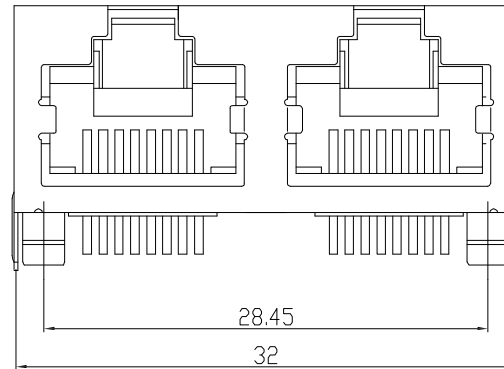
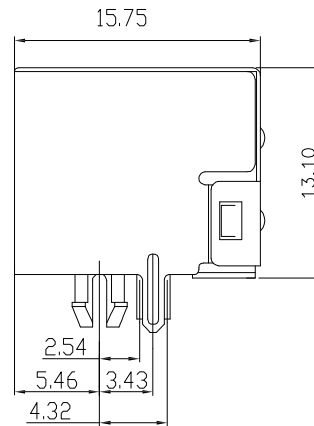
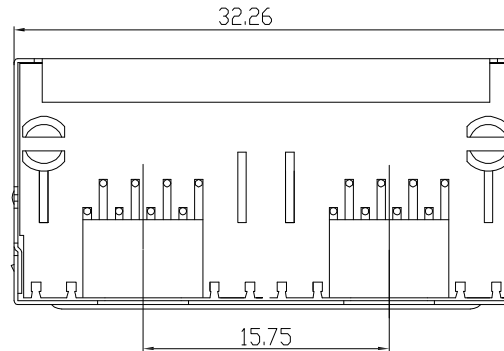
RoHS Compliant

REVISIONS

REV.	DESCRIPTION	DATE	DESIGN



PC Board Layout



NOTES

MATERIAL
1. HOUSING MATERIAL : THERMO PLASTICS UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE ϕ 0.46mm.
3. PLATING : GOLD FLASH PLATING OVER NICKEL.
4. SHIELD : 0.20mm THICKNESS COPPER ALLOY WITH NICKEL PLATED.

ELECTRICAL
1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 100V DC .
5. DIELECTRIC DIELECTRIC RESISTANCE : 500V DC RMS 50Hz. 1MIN.

MECHANICAL
1. DURRABILITY : 750 CYCLES MIN.
2. MATING/UNMATING FORC: 2.24 KG.F MAX.

ENVIRONMENTAL:
1. OPERATION : -40°C ~+85°C.
2. STORAGE : -40°C ~+85°C.

PART NO. INFORMATION

RJ01- X 5 X X - 090

CONTACT PLATED
1: G/F 2: AU 3U"
3: AU 6U"

PACKAGE
R: TAPE REEL
T: TRAY

HOUSING:
1:PBT BLACK

Bestcreate Technology Limited

TOLERANCES UNLESS OTHERWISE SPECIFIED:

.X	±	0.35	X.*	±	3"
.XX	±	0.25	.X.*	±	2"
.XXX	±	0.15	.XX.*	±	1"

Website: www.bsc-elec.com
Email: bestcreate@bsc-elec.com

DESIGN: DATE:

I. L 2017. 3. 1

CHECKED: DATE:

C. W 2017. 3. 1

APPROVED: DATE:

C. W 2017. 3. 1

TITLE:

56S 1x2 8P8C DIP TYPE

MATERILA:

PART NO: RJ01-X5XX-090

SIZE: A4

FINSH:

DWG NO: RJ01-X5XX-090

REV: A

UNIT mm

SCALE 1=1

QUALITY SYMBOLS

